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IMPEDANCE RELAXATION SPECTRUM ANALYSIS OF

OXIDIZED SILVER ELECTRODES

by

Maria Hepel and Micha Tomkiewicz

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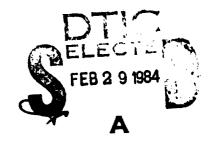
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We have found that at the potential in which AgO is formed, significant fraction of the charge is being used for formation of Ag₂O.



IMPEDANCE RELAXATION SPECTRUM ANALYSIS OF OXIDIZED SILVER ELECTRODES

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KEY WORDS: Impedance, Anode, Films, Discharge

ABSTRACT

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The real and imaginary parts of the impedance of the oxidized silver electrode in 1M KOH solutions, have been measured in a frequency range of 1 - 1.3 x 10 Hz.

When the electrode is oxidized at a potential when only Agro is formed, we were able to isolate three passive elements: the high frequency capacitance and the high and low frequency resistances. On further oxidation, at a potential in which Ago can be formed, we were able to isolate five passive elements: two capacitive and three resistive. Two of these elements were identified as originating from the Agro layer. The functional dependence of all these elements on the amount of charge that is used for oxidation, reveals that the Agro layer can be analyzed in terms of a single dielectricum in a parallel plate capacitor. Parameters such as thickness of the layer, resistivity of the material and roughness factor could be evaluated.

We have found that at the potential in which AgO is formed, significant fraction of the charge is being used for formation of $Ag_2^{\eta}O$.

INTRODUCTION

The electrochemical behavior of silver - silver oxide electrode has been extensively studied (1-7) because of the importance of electrochemical storage systems such as silver - zinc, silver - cadium, silver - iron and silver-hydrogen batteries. It is known (8) that in alkaline solutions, silver is oxidized in two steps. Upon initial oxidation Ag₂0 is formed which can be further oxidized to AgO. Impedance measurements (3,9) in addition to more conventional electrochemical methods, were used extensively, to characterize the chemical and morphological mechanism of the oxidation process(10). The technique of Relaxation Spectrum Analysis in which the impedance is monitored over a wide frequency range and the results are portrayed in terms of a set of parallel, frequency independent, R-C elements, was used in the past to describe the potential distribution at the semiconductor electrolyte interface (11). Recently, the technique was extended to characterize the interface of metallic single crystal RuO₂, with aqueous electrolytes (12).

The principal condition under which one can apply this mode of interpretation to the frequency dispersion of the impedance of the interface, is that the faradaic components will be negligible during the impedance measurements. Thus, if this condition is satisfied, the impedance measurements are used to monitor static characteristics of the interface and changes in these characteristics due to perturbation of the system prior to the impedance measurements. The correlation between the changes in the static characteristics and the perturbations which give rise to them, provide the tools for understanding certain aspects of the dynamics of the system. The generalized equivalent circuit, which is based on a network of parallel R-C elements and which was so useful for the simple interfaces is clearly not appropriate for the study of the oxidation of the silver electrode.

 ${\rm Ag}_20$ is a small band gap (1.2 eV at $293^{\rm o}{\rm K}$ (13)) semiconductor which is insulating with resistivities of the order of 10^6-10^8 $\Omega{\rm cm}$ at room temperature (14). Although its electronic properties are not as well characterized as those of the better known semiconductors, and not even, as well, as the properties of its structural analoge, ${\rm Cu}_20$, there is no known methods of doping this material to reduce its resistivity to the region in which its semiconducting properties will dominate.

Our knowledge of the solid state properties of AgO are even less complete then that of ${\rm Ag}_2{\rm O}$. Since it was impossible to grow stable single crystals of this material. There is still an uncertainty whether the material have peroxide structure in the form of Ag₂0₂ or it actually represents higher oxidation state of the silver. It was characterized as an n type semiconductor, with a bandgap of ~2 eV (15). Unlike for Ag₂O, its resistivity can be reduced considerably down to a level of $\sim 10 \, \Omega cm$ (17,18). Since these two oxides vary so much in their transport properties it is natural that zero order interpretation of the impedance data should assume their separate contributions to the transport properties in series with each other. This simplified assumption should result in two possible R-C elements connected in series. If, on the other hand, AgO is formed not by direct oxidation of Ag₂O at the oxide electrolyte interface, but instead through nucleation, then a random distribution of the two oxides may be expected. Such a random distribution can not be analyzed in terms of well defined, dielectric materials connected in series, but rather as a changing dielectric constant of a random composite that can be analyzed by utilizing effective medium theories (19) that can calculate the frequency distribution of the dielectric constant of the composite as a function of its changing composition.

In this paper, we present evidence, that under certain experimental conditions, the evolution of the two oxides can be separately monitored. We present evidence that at least Ag₂O behaves as a pure dielectricum with

frequency independent dielectric constant and we follow the growth of Ag₂0 as it is being further oxidized to Ag0.

EXPERIMENTAL

Apparatus

The experimental set-up for impedance measurments was similar to the one described elsewhere (11). It consisted of a Hewlett-Packard 3320-B frequency synthesizer, 3575-A gain-phase meter and dc-bias supply. The system control and data aquisition were performed by a Hewlett-Packard Model 9830A micro-computer. The experimental data, relative magnitude M and phase shift Φ between the two input signals (impedance of the reference circuit and total impedance), were processed and analyzed by a computer interactive program. The electronic equipment used allowed for measurements up to the frequency 13 MHz, a limit practically unavailable for potentiostatic systems.

On the other hand, special precautions concerning the electrochemical cell design (similarly as in case of the bridge methods) had to be undertaken. Although, balancing the reference impedance and the cell impedance is not required for the method to be used, a comparable value of the reference impedance was always maintained in order to achieve the best accuracy of readings. The parasitic inductance of leads has been diagnosed and all the results presented here are corrected for the high-frequency inductance effects.

Electrochemical cell and materials

The electrochemical cell used for measurements was a standard two-compartment plexiglass cell of a capacity 100 cm³. The counter electrode was made from a large graphite cylinder. A double-junction saturated (KCI) silver/silver chloride electrode with 1M KNO₃ external solution was used as a reference electrode. A high purity silver rod substrate (Johnson-Matthews, 99.99%) with an exposed surface area 0.385 cm² was used as a working electrode. The oxides films were prepared on this substrate according to a procedure

described below.

All chemicals used were of analytical grade purity. De-ionized water (18 Mohm) was obtained using Mili-Q purification system.

Experimental procedure

The polycrystalline silver substrate electrodes were polished to a mirror like surface using alumina with 0.03 µm grains. The surface was subsequently degreased in acetone and propyl alchohol, etched in diluted HNO3 solution, rinsed with de-ionized water and dried in air. The bi-layer electrodes were prepared in two steps. During the first step an Ag_20 film was deposited in 1 mol/dm^3 KOH solution at constant potential E = + 300 mV (vs. Ag/AgCl doublejunction reference electrode) using standard electrochemical equipment (a Model FG & G 173 potentiostat, equipped with a Model 179 digital coulometer and Model 175 universal programmer.) The deposition was carried out for several hours and was interrupted after a given charge had been passed through the cell. Then the electrode potential was increased to + 600 mV, to the region of the AgO formation. The deposition was carried out for different times allowing for a growth of the oxide films of different thicknesses. The anodic charge consumed in the second step was from 0.47 C to 15.1 C. The electrodes obtained in this way were then subsequently used in the impedance measurements with the network analyzer set-up described above.

All the solutions used were deoxygenated by passing argon. During the experiments an argon purge was maintained.

Results and Discussions

Figure 1 shows the cyclic voltamogram of oxidation and reduction of the silver/silver oxides electrode with the arrows indicating at which potentials the films were oxidized and the potentials at which the impedance of the system was measured. Figure 2 shows the impedance spectrum of the system when only Ag₂0 is deposited and Figure 3 shows the impedance spectrum with 0.44C used for Ag₂0 deposition, following by further oxidation to form Ag₀.

Similar data were taken for different amounts of deposition charge.

Next a generalized way of analyzing these results will be presented, followed by a detailed account of the Ag/Ag₂O and Ag/Ag₂O/AgO systems.

1. Relaxation Spectrum Analysis in a series presentation

If the generalized equivalent circuit of the system is presented as series of passive R-C elements like the one shown in Figure 4(a), with R_s , the series resistance due to the electrolyte, r_s^i - the series resistance of phase i and C_p^i and R_p^i the capacitance and shunt resistance of phase i. If phase i behaves like an insulator then r_s^i = 0 and C_p^i and R_p^i will relate, through the geometry of the system and the frequency, to the real and imaginary parts of the dielectric constant. If, on the other hand, phase i behaves like a semiconductor with space charge layer which is small compared to the thickness of the material, then only r_s^i relates to the resistivity of the system and C_p^i and R_p^i will relate to the charge distribution at the space charge layer and will vary with the potential drop across phase i. The impedance of such an equivalent circuit is given by:

$$Z = R + jX = R_s + \sum_{i=1}^{n} Z^{i}$$
 (1)

where R and X are the real and imaginary components of the impedance.

$$z^{i} = r_{s}^{i} + \frac{R_{p}^{i}}{1 + j\omega\tau^{i}} = r_{s}^{i} + \frac{R_{p}^{i}}{1 + (\omega\tau^{i})^{2}}$$

$$-J \frac{\omega R_{p}^{i} \tau^{i}}{1 + (\omega\tau^{i})^{2}}$$
(2)

where ω is the angular frequency and $\tau^1 = R_p^1 C_p^1$, the relaxation time characteristic of phase i. Substituting eq. (2) in eq. (1) we will obtain the following expressions for the real and imaginary parts of the total impedance:

$$R = R_{s} + \sum_{i} r_{s}^{i} + \sum_{i} \frac{R_{p}^{i}}{1 + (\omega r^{i})^{2}}$$
 (3)

$$X = - \underset{i}{\text{wr}} \frac{R_{p}^{i} \tau^{i}}{1 + (\omega \tau^{i})^{2}}$$
(4)

Thus, as in the parallel case, a function can be formulated, in this case simply by the imaginary part of the impedance, in which one obtains a line shape which is superimposition of Lorentzians type peaks. If the various contributions can be resolved, then the number of peaks will indicate the number of components i, and each peak will be centered at $\omega = \frac{1}{\tau_i}$ and X at the maximum will be equal to $R_p^i/2$, from which one can readily evaluate C_p^i and R_p^i .

From the high frequency compenents of the real part one can evaluate $R_s + \sum_{i=s}^{r} i$. The individual r_s^i can not be evaluated by this technique.

Figure 3 shows the impedance spectra, when both Ag₂0 and Ag0 are present. The imaginary part of the impedance, even in the logarithmic scale, shows clearly two main peaks. It remains to be established whether either of these peaks is due to a single relaxing, passive, R-C element, but clearly the procedure that was established here offers the best starting point.

Figure 2, shows the impedance spectra when only Ag₂0 is present, it does not show any resolvable peaks in the imaginary part. The behavior here, resembles the one observed with single phase interfaces and which was analyzed (11) in terms of a network of parallel RC elements as shown in Fig. 4b. We will not attempt full analysis of the network here and will concentrate only on the fastest relaxing RC element and the shunt resistance R(0).

It should be emphasized that the analysis of the data in terms of parallel or series networks is not unique and is a matter of convenience only. It serves primarily to isolate charge accumulation modes according to their relaxation times.

2. Ag/Ag₂0 System

Under the conditions in which Relaxation Spectrum Analysis on parallel

network can be performed, there exists a frequency region in which the equivalent circuit can be reduced to a single R-C element(11). In this frequency range, the impedance is given by:

$$Z_{HF} = R - \frac{j}{\omega C_f} \tag{5}$$

In this region

 $\log (2\pi X) = -\log f - \log C_f$ (6) and $log(2\pi X)$ should be linear with log f with a slope of -1 and an intercept from which Cf can be extracted. The real part, is frequency independent and equal to $R_{_{\rm S}}$, the series resistance of the system. From Fig. 2, the frequency range of 8000 - 800000 Hz satisfy these criteria (curve III in Fig. 2). The exact frequency domain in which these criteria are met varies from experiment to experiment. For each experiment the entire frequency dispersion of the impedance was measured, the frequency domain with the fastest relaxing R-C element was identified and the resistance and capacitance values measured. The variations of these parameters with the amount of charge that was passed to oxidize silver to ${\rm Ag}_{\rm 2}0$ will be discussed in this section. The oxidation was done at a constant potential of 0.3 V vs. Ag/AgCl with different oxidation times and the measurements were taken at the rest potential which has changed little in the limits 0.19 - 0.24 V vs. Ag/AgCl with increasing film thickness. For each experiment the electrode was freshly polished.

Figure 5 shows the results of the dependence of $1/C_{\rm f}$ on the oxidation charge Q. Figure 6 shows the dependence of $R_{\rm S}$ on Q which was taken from the high frequency component of R, the same figure also shows the dependence on Q of R(1), the real part of the impedance at low frequency. The spread in the data is considerable, nevertheless a few qualitative conclusions can be drawn:

- (1) $R_{_{\mathbf{S}}}$ is independent of Q and can be shown to be dominated by the resistance of the electrolyte.
- (2) $C_{\hat{f}}$ decreases as Q increases while R(1) remains approximately constant with a large spread of the data.

If we attempt to treat the system as a parallel plate capacitor in which Ag₂0

serves as the dielectricum and further assume a unit Faradaic efficiency for formation of Ag₂0 then:

$$Q = \frac{2FdYAE}{M} \tag{7}$$

where F is the Faradaic number, d - the density, A - the geometric area, ℓ - the thickness of the capacitor and Y - the roughness factor and M - the molecule weight of Ag_2O . The capacitance will be given by:

$$C = \frac{\varepsilon_0 \varepsilon_{YA}}{\ell}$$
 (8)

where ϵ is the dielectric constant and ϵ_0 is the permittivity of free space. The resistance, R_T , which is associated with this dielectricum is given by:

$$R_{T} = \frac{p!}{\gamma_{A}}$$
 (9)

where ρ is the resistivity of Ag_2^{0} . Substituting ℓ from (7) into (8) and (9) one gets:

$$\frac{1}{C_{\rm T}} = \frac{MQ}{2Fd \in \epsilon_{\rm A}^2 \gamma^2} \tag{10}$$

$$R_{T} = \frac{\rho MQ}{2FdA^{2}\gamma^{2}} \tag{11}$$

These equations predict linear behavior of $\frac{1}{C_T}$ and R_T with respect to Q and they predict also that $T = R_T C_T = \rho \epsilon \epsilon_0$ is independent of the geometric factor involved.

The data from Fig. 5 can be analyzed in terms of equation (10) after correcting for C_e , the capacitive element on the electrolyte side of the

$$\frac{1}{c_{f}} = \frac{1}{c_{T}} + \frac{1}{c_{e}}$$
 (12)

Analysis of Fig. 5 in terms of equations (10) and (12) yields intercept of $8 \times 10^5 \, \text{F}^{-1}$, slope of $8.5 \times 10^6 \, \text{C}^{-1} \, \text{F}^{-1}$ with correlation coefficient of 0.92.

interface, such that:

The dielectric constant of Ag_2^0 is not reported in the literature, but the variations in similar solids (oxides and non-oxides) are all within the range of 5 - 10. If we take the dielectric constant of Ag_2^0 to be similar to that of Cu_2^0 which is its structural analog, then $\epsilon \approx 7$. Taking $d = 7.44g/cm^3$, M = 232 and $A = 0.385cm^2$, one can calculate from the slope of Fig. 5 and from equation (10) that $\gamma = 14$ and from the intercept we obtain: $C_e = 3.2 \times 10^{-6} F/cm^2$ if one considers the capacitance/geometric area and $C_e = 2.3 \times 10^{-7} F/cm^2$ if one takes into account the roughness factor. These values are on the low side of the capacitance of the Helmholtz layer, but the quality of the data and the assumptions in the model makes further speculations unwarranted.

If, at least qualitatively, the data in Fig. 5 could be analyzed in terms of equation (10) it is obvious that the data in Figure (6) can not be analyzed in terms of equation (11). R(1) does not represent R_T . We will return to the possible characterization of R(1) in the next section. At this stage, since we do not possess, as yet, information about the resistive component across the oxide, we can not evaluate the relaxation time of the material. Hence, we can not evaluate its resistivity.

3. Ag/Ag₂0/Ag0 System

For this set of experiments the amount of charge, used for Ag₂0 formation was kept constant at 0.44C. We then increased the potential to E = 0.600 V vs. Ag/AgCl, where AgO formation takes place (see Fig. 1). We have measured the impedance at the rest potential of Ag₂0/AgO which is 0.450 V vs Ag/AgCl. We have measured the impedance as a function of the amount of charge that was used for deposition of AgO. Figure 3 shows a typical result of such a measurement. As was mentioned in section 1, even on a logarithmic scale, two peaks, one at high frequency and the other at low frequencies, can be seen. The procedure that was developed in section 1 will be used as a basis for interpreting the

results. The first step in this process is to establish whether either of these peaks is due to a single relaxing, passive, R-C element. Examination of the low frequency peak in Fig. 3 clearly shows that the peak is too broad for a single Lorentzian. Figure 7 shows the evolution of the frequency dispersion of the imaginary part of the impedance with the amount of charge that was used to form the oxide. The amplitude of the high frequency peak increases in direct proportion to the deposition charge, while the high frequency tail of the low frequency peak is little affected by the deposition. Figure 8 shows the numerical fit of the high frequency peak to a normalized single Lorentzian. Except at the tail ends of the peak where inductance dominate on the high side and low frequency contributions on the low side, the fit is very good and the peak will be treated as a single Lorentzian.

As was mentioned before the low frequency peak is much too broad for a single Lorentzian. We do not want here to speculate about the various processes that might contribute to this peak. Figure 7 shows that the high frequency tail of this peak remains constant with deposition charge. It will be useful to determine whether this high frequency tail corresponds to a single passive R-C element. From eq. (4), the contributions of a single Lorentzian to the imaginary part of the impedance is given by:

$$x^{i} = -\frac{\omega R_{p}^{i} \tau^{i}}{1 + (\omega \tau^{i})^{2}}$$
 (13)

The high frequency tail of this peak is defined for $\mathbf{w}^{i} >> 1$. Under these conditions:

$$x^{i} = -1/\omega c_{p}^{i} \tag{14}$$

and the analysis will be similar to the high frequency component of the parallel case which was used in section (2).

Figure 9 shows the fit between the experimental points at the high frequency tail of the low frequency peak and equation (14). The fit is good for nearly two orders of magnitude of frequencies. From the intercept of this

curve:

$$Cp = 4.10^{-5} F = 1.0 \times 10^{-4} F/cm^2$$

based on the geometric area of the electrode.

Based on the boolute value of C_p and particularly observation that it is nearly independent of the amount of AgO deposition or Ag₂O growth during the deposition of AgO, it is reasonable to interpret this capacitive element, to be due to the junction between AgO and the electrolyte. It can be dominated by the capacitance of the Helmholtz layer, or by that of the space charge layer in the conductive oxide or by combination of the two. As long as the width of the space charge layer is smaller than the thickness of the oxide, the value of the capacitance will be independent of charge.

Let us now turn our attention to the fastest relaxing R-C element. Figures 10 and 11 show the variation of $1/C_f$ and R_f with the amount of charge Q_1 associated with deposition at 0.6 V on top of 0.44 C associated with Ag_2 0 that was deposited at 0.3 V vs Ag/AgC1. Figures 10 and 11 show that both R_f and $\frac{1}{C_f}$ increase with Q_1 , where Q_1 is the total amount of charge deposited at 0.6 V vs. Ag/AgC1, then they both saturate at $Q_1 > 5C$. If we neglect the low coverage (up to 0.5C) where nucleation is known to take place, the functional dependence can be represented by:

$$\frac{1}{c_f} = \frac{5.6 \times 10^7 Q_1}{1 + 1.1 Q_1}$$
 (15)

$$R_{f} = \frac{187Q_{1}}{1 + 0.67 Q_{1}} \tag{16}$$

The inserts in both figures show the fit of the experimental points to this presentation from which the constants in equations (15) and (16) were evaluated If we take the saturation in both $R_{\hat{f}}$ and $C_{\hat{f}}$ to indicate saturation in the formation of the dielectric material that is responsible for the high frequency peak, then, within the parallel plate approximation:

$$\tau = (R_f C_f)_{sat} \approx 5.10^{-6} sec = p \epsilon \epsilon_0$$
 (17)

Taking again, as in (2) $\varepsilon = 7$, we obtain $\rho \approx 8.2 \times 10^6$ Ω cm.

The high resistivity can only be due to Ag20. We arrive here to the conclusion that at the potential at which we form AgO, characteristics of the Ag₂0 layer changes as well. If Ag0 is being formed by oxidation of Ag₂0 whose thickness does not increase the expected changes would have been the exact opposite to the one actually observed. We would have expected the Ag₂O layer to decrease in thickness with oxidation which would have resulted in decrease in resistance and increase in the capacitance of the layer. The observed results in Figures 10 and 11 can be interpreted in two ways: either at this potential both oxides are formed and if AgO is being formed by oxidation of Ag, 0, it implies that Ag₂0 is formed by oxidation of silver faster then it is being oxidized, or alternatively, the high electric field and the deposition of Ag0 on top of the ${\rm Ag}_2{\rm O}$ film results in "electroannealing" of the ${\rm Ag}_2{\rm O}$ film which will considerably decrease the resistivity of the film. We prefer the first interpretation on two grounds: (1) We do not see two kinds of Ag₂0, unless one is willing to accept the idea that the "old" Ag,0 have moved to the low frequency peak. This would have required reduction of few orders of magnitude in the resistivity of Ag₂0 lower than any recorded value for this parameter. (2) According to the "electroannealing" argument, the variation of C_f and R_f with Q is due only to the time spent at the anodic potential. Under galvanostatic conditions Q~ t and it would have been difficult to determine which of these two parameters is the key factor. However, the experiment here was performed under potentiostatic conditions in which the current was time dependent and as a result Q was not linear with t. From equations (15) and (16), in a limited range of Q, both $R_{\rm f}$ and 1/C_f are linear with Q which makes the direct correlation with time highly

improbable.

Assuming, as a result, that Figures 10 and 11 indicate continuous deposition of Ag_2O while Ag_2O is being further oxidized to AgO, we will try to analyze the correlation between R_f and $1/C_f$ with Q in a manner similar to the one that was explored in section 2. Let us assume that fraction α of the charge, Q_1 , was used for the oxidation of Ag_2O to AgO and the remaining charge was used for the oxidation of Ag to Ag_2O . The net amount of charge used for deposition of new Ag_2O is given by:

$$Q_{net} = (1-2\alpha) Q_1$$
 (18)

Following the arguments that led to equations (10) and (11) in section (2), the capacitance and resistance of the newly formed Ag_2O layer will be given by:

$$\frac{1}{c_f} = \frac{n(1-2\alpha)Q_1}{2Fc \varepsilon_o A_Y^2} + \frac{1}{c_f^o}$$
 (19)

$$R_{f} = \frac{\rho M(1-\alpha) Q_{1}}{2fdA^{2}\gamma^{2}} + R_{f}^{o}$$
where C_{f}^{o} and R_{f}^{o} are the values for $Q_{1} = 0$. (20)

Comparing equations (15) and (16) with (19) and (20) prior to saturation one can evaluate $\gamma/\sqrt{1-2\alpha}$ this implies that if we can evaluate the roughness factor in an independent experiment then the ratio between the two oxidation reactions can be evaluated. From equations (19) and (15) one can calculate that $\gamma/\sqrt{1-2\alpha}$ = 15.3.

Up to now we have evaluated all the data that we could extract from the frequency dispersion of the imaginary part of the impedance. From Figure 3 one can observe that at both ends of the frequency spectrum, the real part of the impedance is frequency independent. Fig. 12 shows the dependence of the high frequency component, $R(\infty)$ and the low frequency component, R(1), as a function of deposition charge. The high frequency component resembles the behavior that was shown in Fig. 6, when only Ag_20 was present and is consistent with the interpretation that was made there, that $R(\infty)$ is due to the series resistance, $R_{\mathbf{g}}$, which is due to the electrolyte. R(1) on the other hand, increases with deposition charge in a manner which resembles $R_{\mathbf{f}}$ in Fig. 11. However, the absolute values are considerably smaller than the $R_{\mathbf{f}}$ values. This is in sharp contradiction with equation (2) which demands that:

$$R(0) = \lim_{\omega \to 0} R = R_s + \Sigma r_s^i + \sum_{i} R_p^i$$
(21)

Since R_f is one component of this sum, equation (21) requires that $R(0) > R_f$. Since the low frequency part of the imaginary part of the impedance was shown to result from multiplicity of unresolved processes, we do not feel secure in proposing a definite pathway for these frequencies. More work is needed, before some definite conclusion about the low frequency regime can emerge.

CONCLUSIONS

We have shown that impedance measurements can be used to gain information about the chemical and topological changes that take place during oxidation of the silver electrode. Distinction between perturbation and detection was the key in enabling us to interpret the results using the simplest possible model and to correlate the measurements with the perturbation in a straightforward way.

We have shown that the technique of Relaxation Spectrum Analysis, which separates the charge accumulation modes at simple interfaces, according to their relaxation times, expressed in terms of simple, frequency independent, RC elements, can be extended to systems in which to first approximation, the charge accumulation modes are in series with each other. Under conditions when only Ag₂O is deposited, the impedance spectra behaved as that of a single interface. We were able to extract three, well behaved, passive elements: the high frequency capacitance, the high frequency resistance and the low frequency resistance. We have tried to identify the physical origin of these elements by monitoring their dependence on the amount of charge that was used to oxidize the electrode. The resistive element was found to be independent of charge while the reciprocal of the capacitive element have increased in a linear way with the amount of charge. The functional dependence of the capacitive element on the amount of charge was consistent with a simple model of a parallel plate capacitor in which Ag20 serves as the dielectric material. Based on this model an "average" roughness factor, which is independent of the thickness of the layer was

calculated and found to be ~ 14. Based on this model, we were able to determine that, at least for the conditions that were investigated here, Ag₂0 behaves as an insulator in which the electric field is distributed across the entire sample and does not concentrate at the interface. The high frequency resistance was associated with the resistivity of the electrolyte, while the low frequency resistance was associated with kinetic effects. At the potential in which the silver can be oxidized to AgO, we were able to extract five well behaved, passive elements and to monitor their variation with the amount of deposited charge. We were able to isolate the capacitive and resistive elements of a single dielectricum . In terms of a parallel plate model, these two parameters relate to the real and imaginary parts of the dielectric constant of the material through the geometric factor of the capacitor. The relaxation time of this material was found to be $\approx 5.10^{-6}$ sec from which resistivity of ~ 8.10 6 $\,\Omega\,\text{cm}$ was evaluated. The high resistivity, clearly demonstrates that the material is still Ag₂0. The conclusion was that at the potential where silver can be oxidized to AgO, significant fraction of the charge goes for an increase in the thickness of the Ag₂0 layer. For amount of charge in excess of $\approx 15 \text{ C/cm}^2$, the capacitive and resistive elements which are associated with the Ag₂O₃ saturate and a steady state is achieved between formation of Ag₂0 and oxidation of Ag₂0 to Ag0.

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Figures

- Figure 1. The CV characteristic for the polycrystalline silver electrode (geometric area A = 0.385 cm²) in 1 mol dm⁻³ KOH solution at 22°C. V = 10 mV/s.

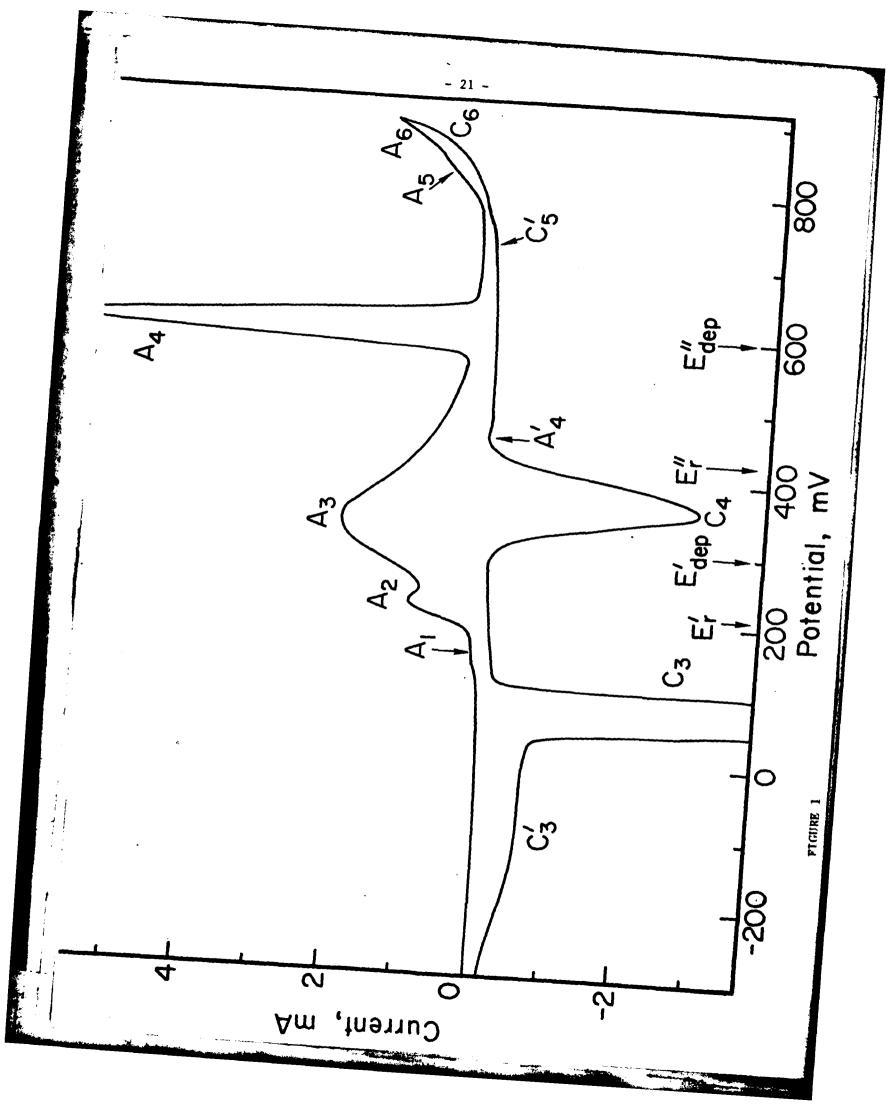
 E'dep and E'dep are potentials of deposition of Ag₂O and AgO, respectively (used in further deposition experiments.)

 E'r and E'r are the rest potentials at which impedance spectra were measured.
- Figure 2. Impedance spectrum for a polycrystalline silver electrode covered by a thin film of Ag₂O deposited at E = +300 mV (vs. Ag/AgCl). (I) Z = log R₁ (II) -Q = log (2 m X), (III) Q = -log t log C_f. Solution: 1 mol dm⁻³ KOH.
- Figure 3. Impedance spectrum for a bilayer Ag/Ag₂0/Ag0 electrode in 1 mol dm⁻³ KOH. Total deposition charge: 2.9 C/cm^2 .

 (I) Q = log R, (II) Q = log (2 π X).
- Figure 4. Generalized equivalent circuit for series (a) and parallel (b) configurations of the passive elements. R_p and C_p are the parallel resistance and capacitance, respectively, for the inner film (prime) and the interface (i); T_s's stand for the respective time constants; R_s is the ohmic resistance mainly due to the electrolyte; R(0) is the low-frequency resistance; C_f is the film capacitance and C₁ R₁ are the series time constants.

- Figure 5. Dependence of the reciprocal of the Ag₂0 film capacitance

 1/C_f determined from the impedance relaxation spectra upon
 the oxide-deposition charge Q. Coefficients of the linear
 fit to the experimental points are given.
- Figure 6. Plot of the experimental data R_g and R(1) vs. deposition charge Q for the Ag/Ag₂O electrode in 1 mol dm⁻³ KOH solution.
- Figure 7. Frequency dispersion of the imaginary part of the impedance of the bilayer Ag/Ag₂0/Ag0 electrode in 1 mol dm⁻³ KOH at various Ag0 deposition charges [C]: (1) 0.91, (2) 1.05, (3) 1.19, (4) 1.48.
- Figure 8. Computer fit of the high frequency reactance peak to a single Lorentzian for different AgO deposition charges [C]:
 (1) 0.91, (2) 1.05, (3) 1.19.
- Figure 9. Fit of the high frequency tail of the low frequency peak to a single Lorentzian for the bilayer Ag/Ag₂0/Ag0 electrode.
- Figure 10. Dependence of the inner film capacitance C_f for the bi-layer Ag/Ag₂O/AgO electrode in 1 mol dm⁻³ KOH upon the reciprocal of the oxide deposition charge 1/Q.
- Figure 11. Plot of the reciprocal of the inner film resistance $1/R_{\rm f}$ vs. $1/Q_1$ for the Ag/Ag₂0/Ag0 layered electrode in 1 mol dm⁻³ KOH.
- Figure 12. Dependence of $R(\infty)$ and R(1) upon the oxide deposition charge Q_1 for the bilayer $Ag/Ag_2O/AgO$ electrode in 1 mol dm⁻³ KOH.



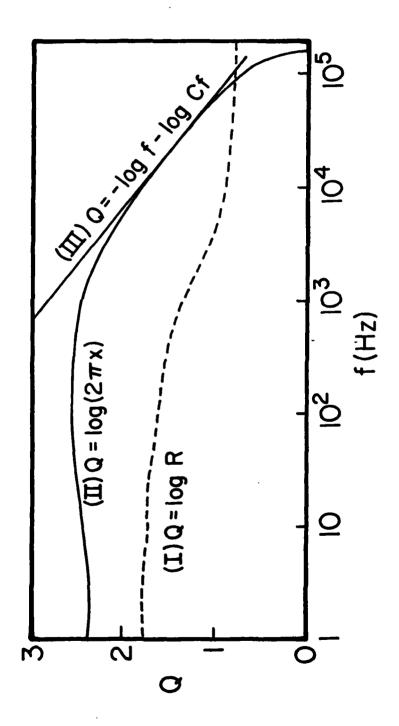


FIGURE 2

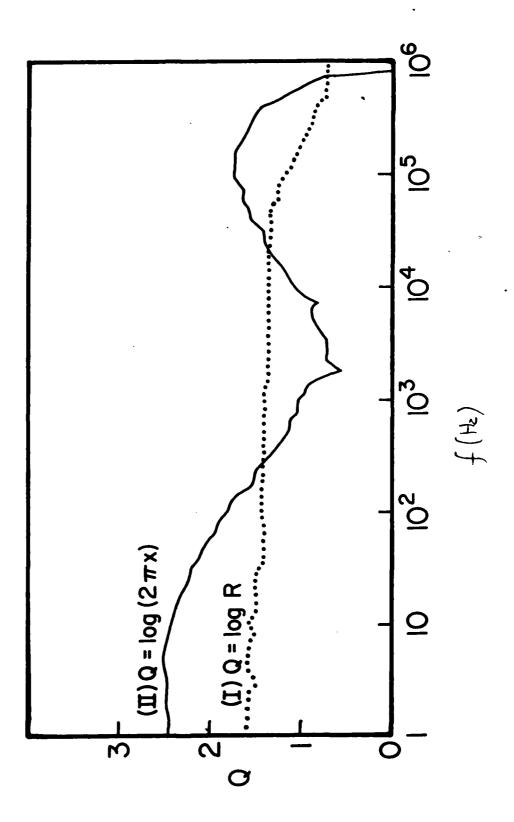
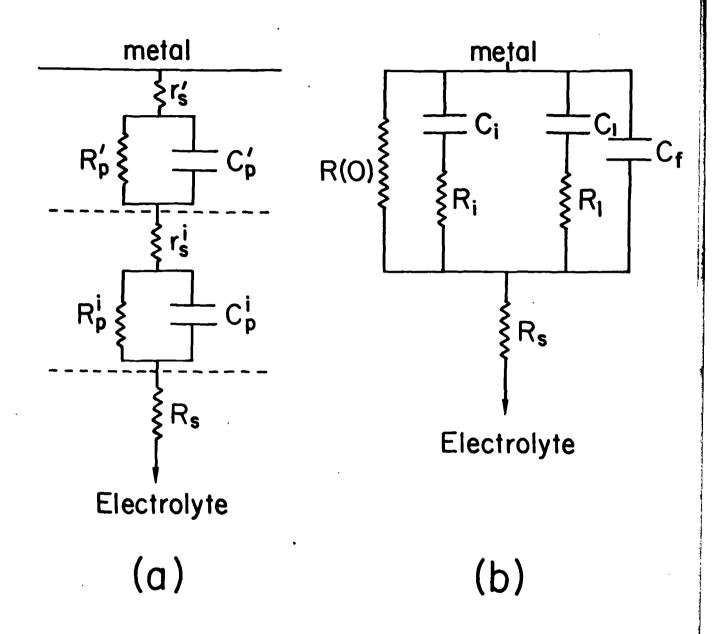
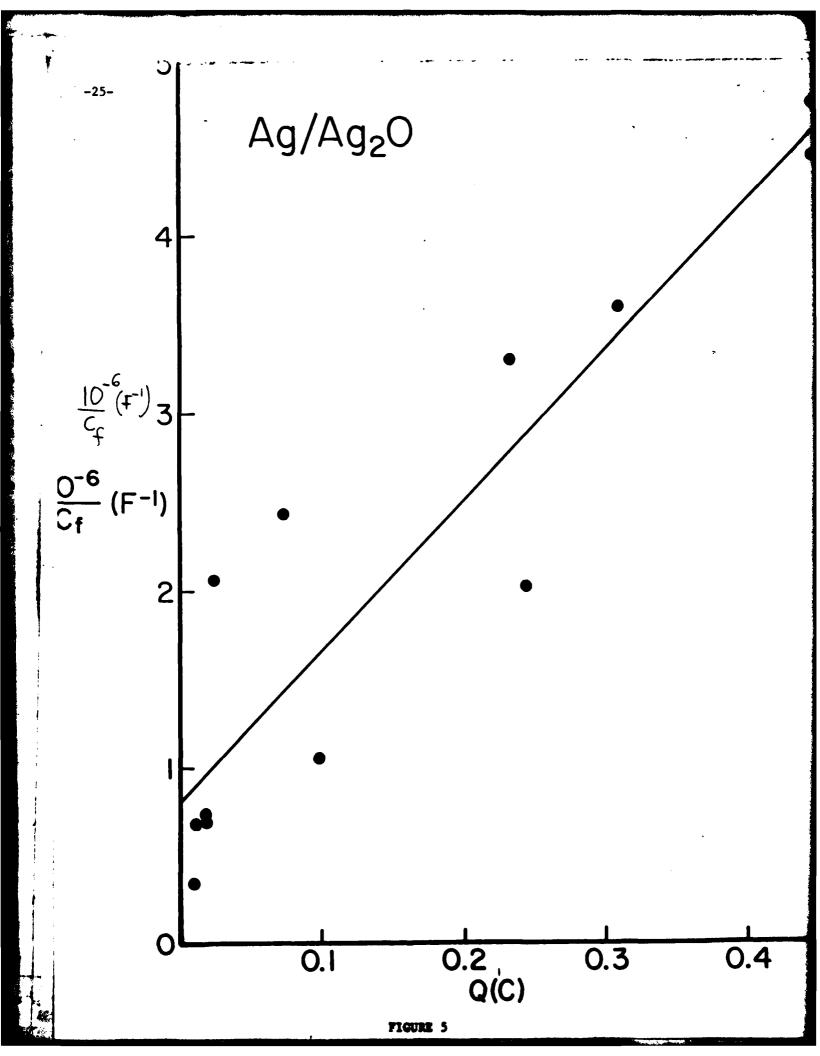
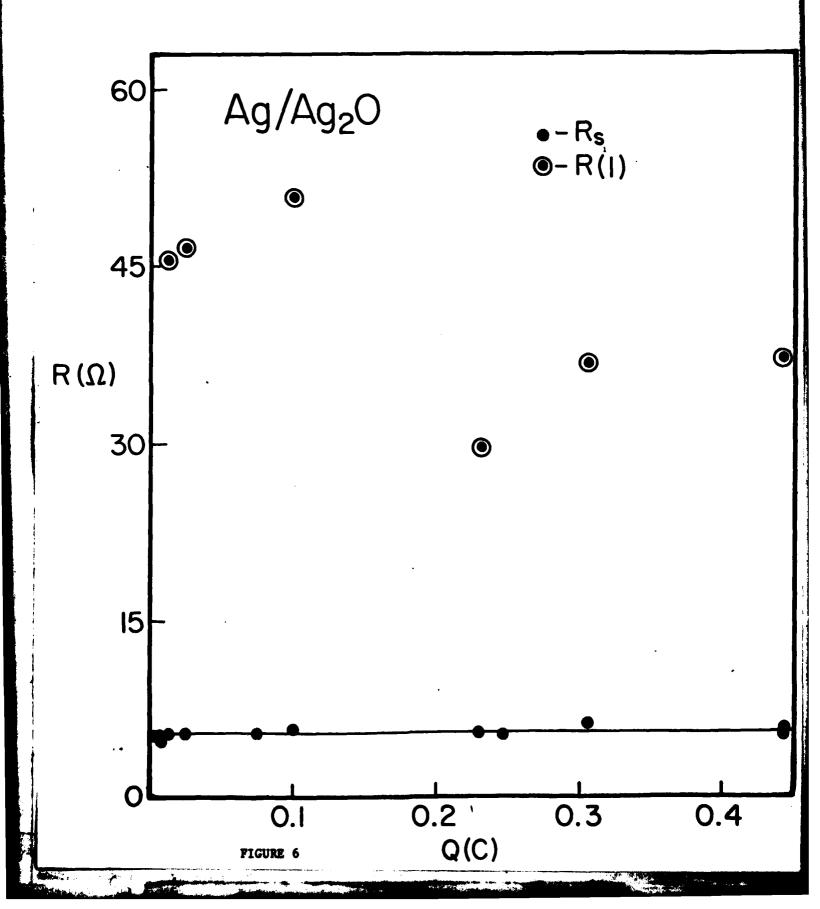
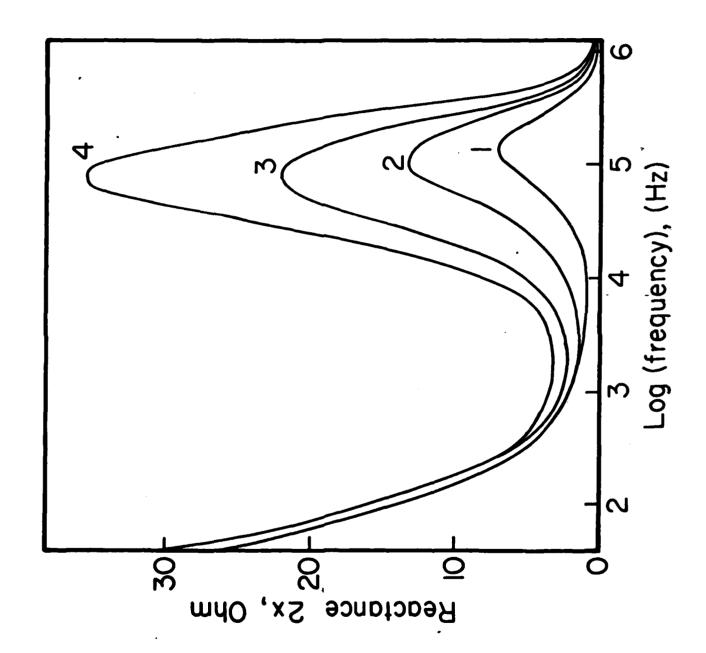


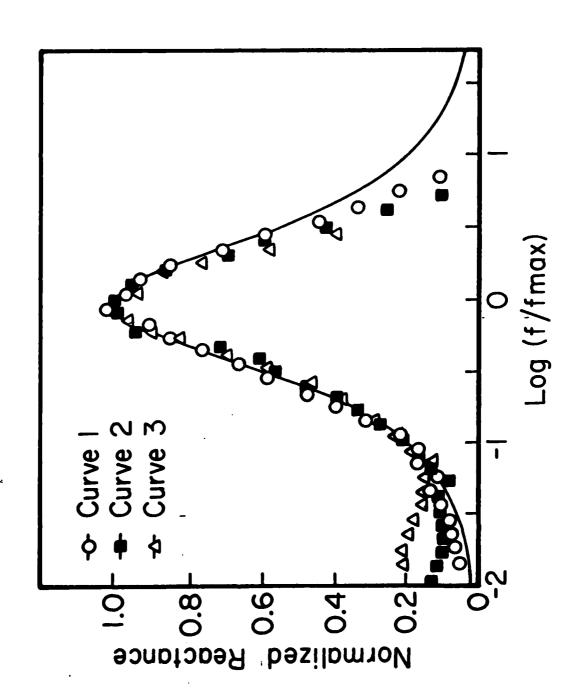
FIGURE 3

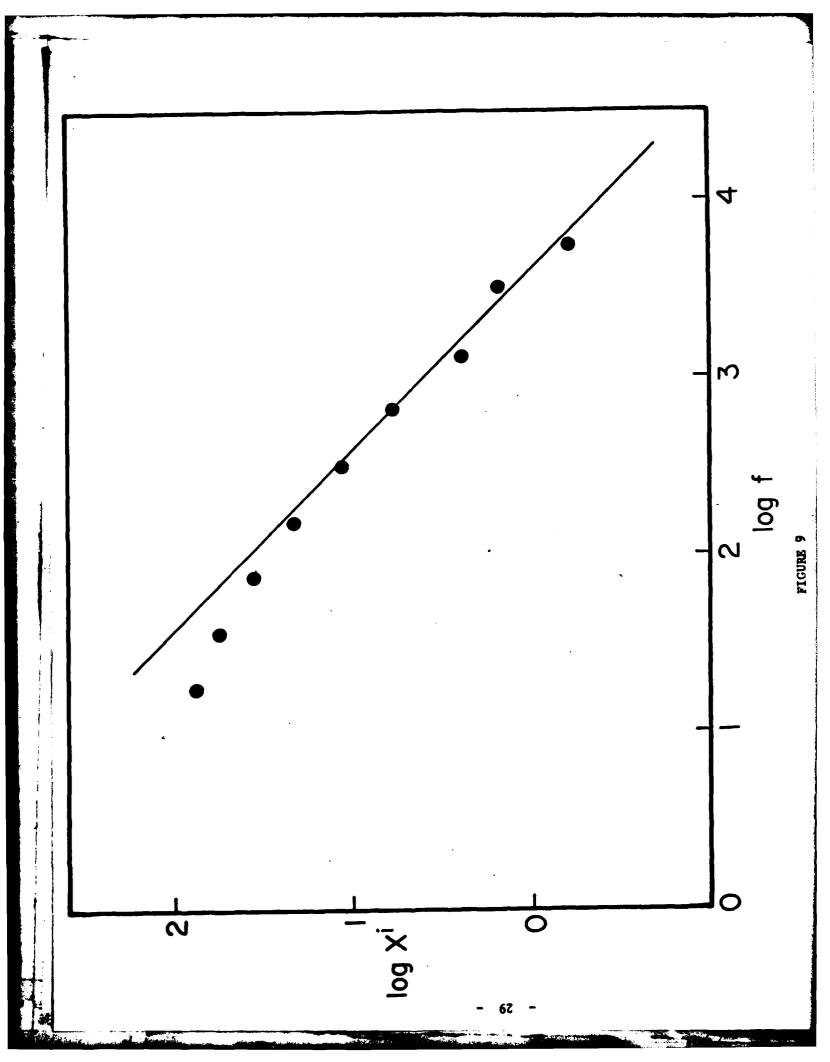


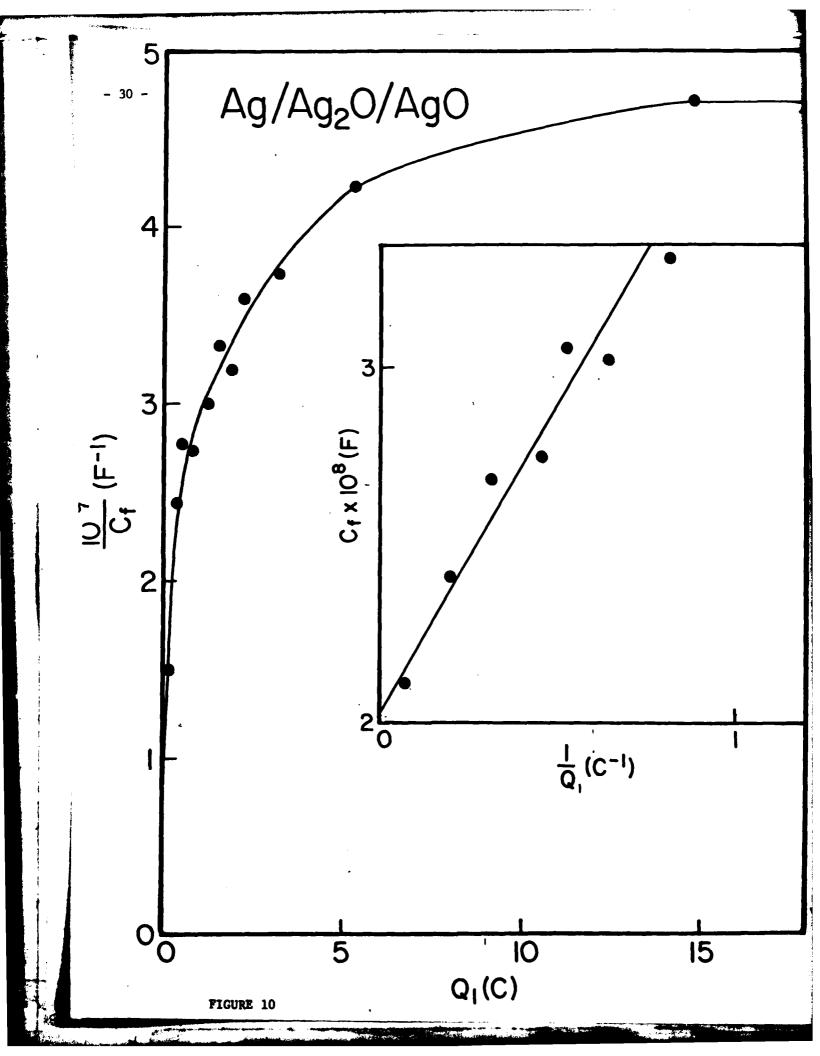


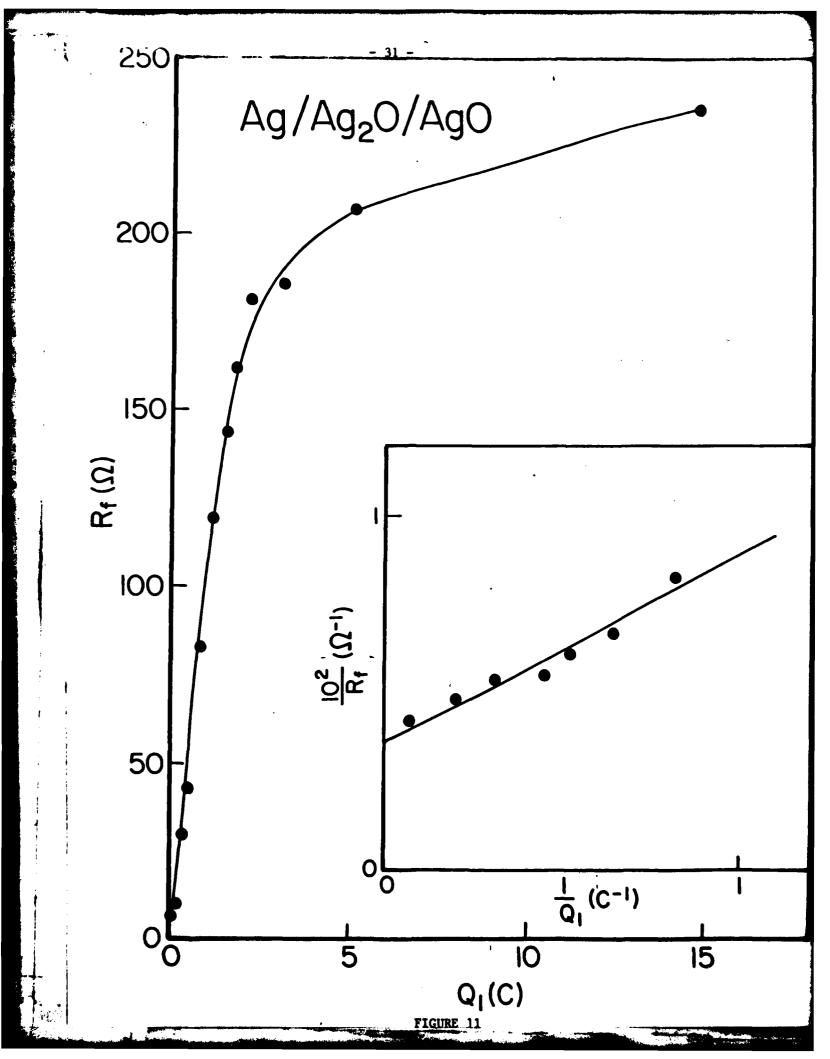


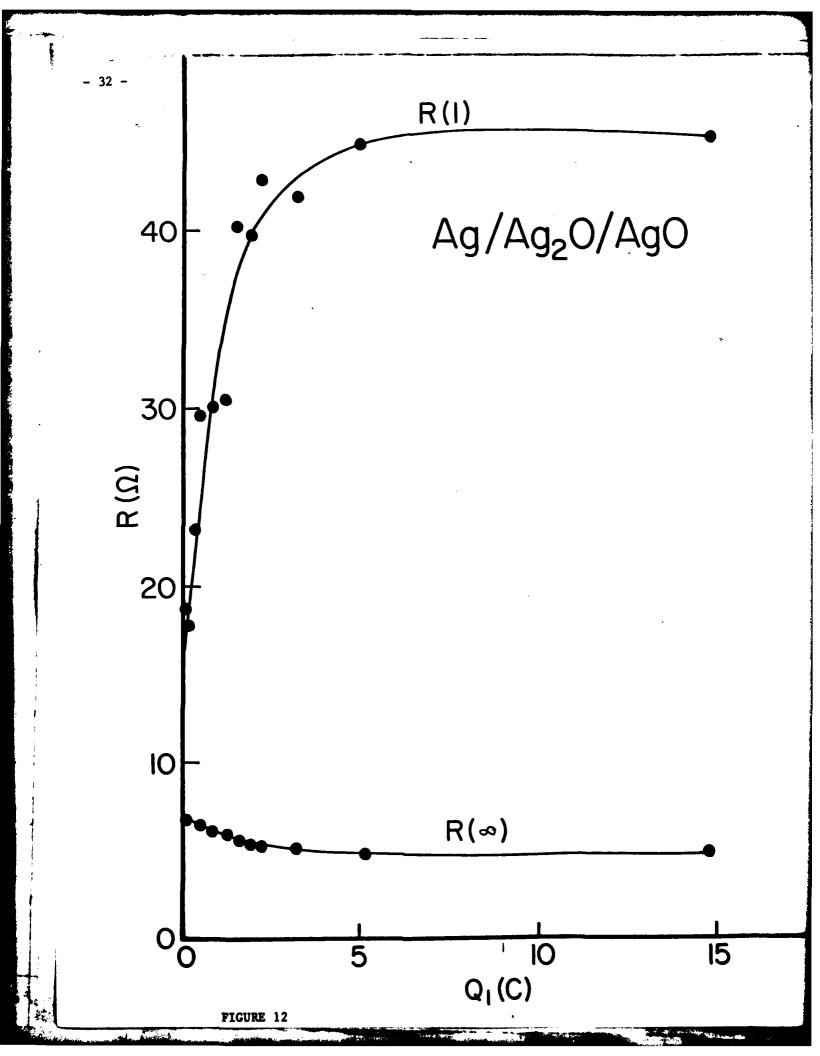












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